Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

STMicroelectronics STS11NF30L

For any questions, you can email us directly: sales@integrated-circuit.com





STS11NF30L

N-channel 30V - 0.0085Ω - 11A SO-8 Low gate charge STripFET™ II Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS11NF30L	30V	<0.009Ω	11A

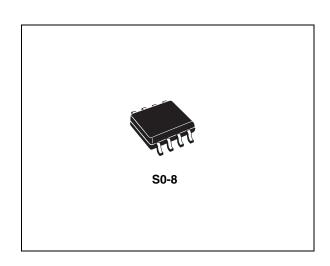
- Optimal R_{DS}(on) x Qg trade-off
- Conduction losses reduced

Description

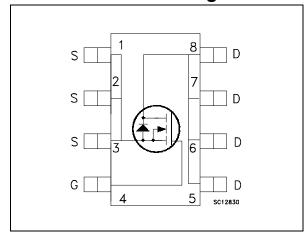
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS11NF30L	11F30L-	SO-8	Tape & reel

January 2007 Rev 11 1/12



Contents STS11NF30L

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuit	E
4	Package mechanical data	٥
5	Revision history1	1



STS11NF30L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate-source voltage	± 18	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C	11	Α
I _D	Drain current (continuous) at T _C = 100°C	7	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	44	Α
P _{TOT}	Total dissipation at T _C = 25°C	2.5	W
	Derating factor	0.02	W/°C
dv/dt ⁽³⁾	Peak diode recovery voltage slope	5.5	V/ns
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150 150	°C

- 1. Current limited by the package
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \le 1A$, di/dt $\le 370A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_j \le T_{JMAX}$

Table 2. Thermal data

R _{thj-a}	Thermal resistance junction-ambient Max ⁽¹⁾	50	°C/W
T _I	Maximum lead temperature for soldering purpose	150	°C

1. When Mounted on 1 inch² FR-4 board, 2 oz of Cu and t [10 sec



Electrical characteristics

STS11NF30L

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			٧
	Zero gate voltage	V _{DS} = Max rating			1	μΑ
I _{DSS}	drain current ($V_{GS} = 0$)	V _{DS} =Max rating, T _C =125°C			10	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 18V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 5.5A$ $V_{GS} = 5V, I_D = 5.5A$		0.0085 0.0145	0.0105 0.0190	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 25V_{,} I_{D} = 5.5A$		15		S
C _{iss}	Input capacitance			1440		pF
C _{oss}	Output capacitance	$V_{DS} = 25V, f = 1 MHz,$		560		pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$		135		pF
Qg	Total gate charge	15)/ 15		22.5	30	nC
Q_{gs}	Gate-source charge	$V_{DD} = 15V, I_D = 11A,$ $V_{GS} = 5V$		9		nC
Q_{gd}	Gate-drain charge	·GS = • •		12		nC

^{1.} Pulsed: Pulse duration = $300 \mu s$, duty cycle 1.5.

Table 5. Switching times

iabic 5.	Owitering times					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =15 V, I_{D} =5.5A, R_{G} =4.7 Ω , V_{GS} = 5V (see Figure 13)		22 39		ns ns
t _{d(off)}	Turn-off-delay time Fall time	V_{DD} = 15V, I_{D} = 5.5A, R_{G} = 4.7 Ω , V_{GS} = 5V (see Figure 13)		23 16		ns ns





STS11NF30L

Electrical characteristics

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				11	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				44	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 11A, V_{GS} = 0$			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 11A, V_{DD} = 20V di/dt = 100A/µs, T_j = 150°C (see Figure 15)		42 52 2.5		ns nC A

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %

Electrical characteristics

STS11NF30L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

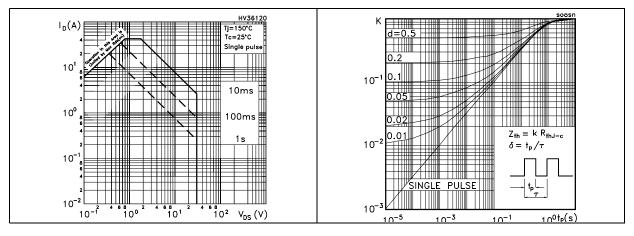


Figure 3. Output characterisics

Figure 4. Transfer characteristics

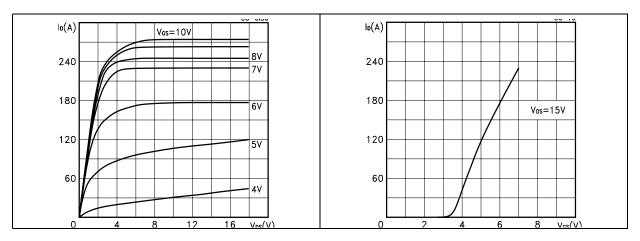
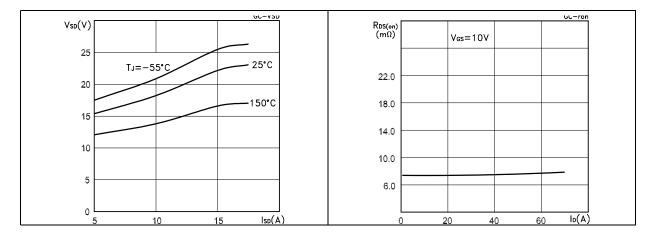


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



577

STS11NF30L

Electrical characteristics

Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

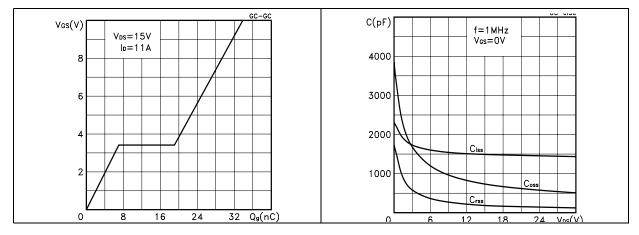


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

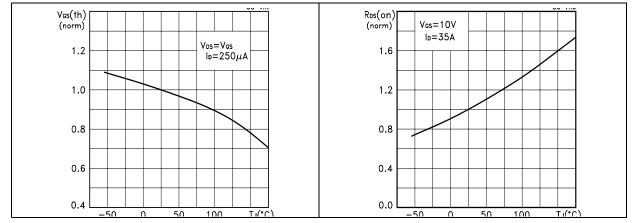
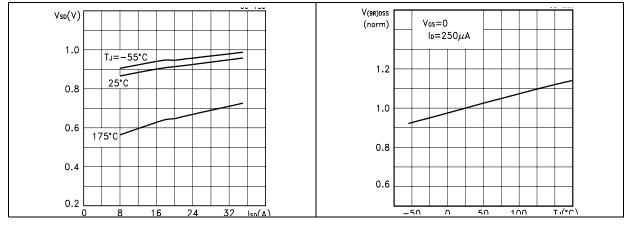


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized Breakdown Voltage vs Temperature







Test circuit STS11NF30L

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

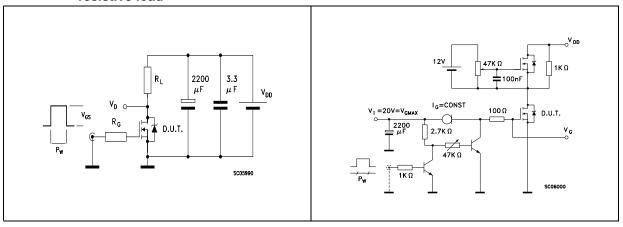


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

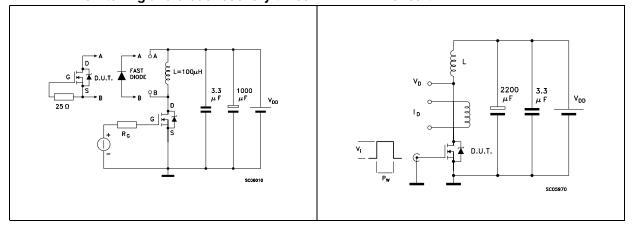
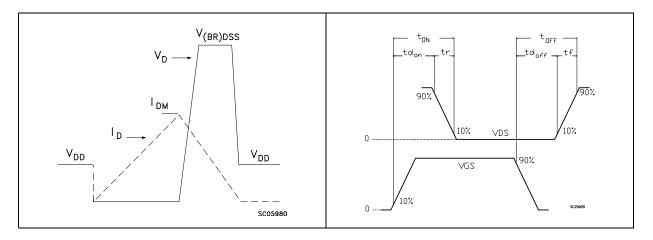


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform





Distributor of STMicroelectronics: Excellent Integrated System Limited

Datasheet of STS11NF30L - MOSFET N-CH 30V 11A 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

STS11NF30L

Package mechanical data

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



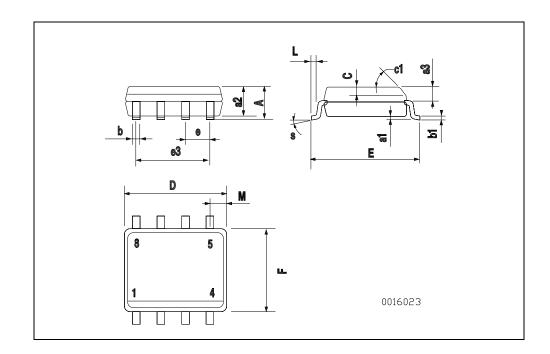


Package mechanical data

STS11NF30L

SO-8 N	MECH	IANIC	AL	DATA
---------------	------	-------	----	------

DIM.		mm.				
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45 ((typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (n	nax.)		





STS11NF30L Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	9	Complete version
17-Aug-2006	10	The document has been reformatted
12-Jan-2007	11	Updates in Safe operating area





Distributor of STMicroelectronics: Excellent Integrated System Limited Datasheet of STS11NF30L - MOSFET N-CH 30V 11A 8-SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

STS11NF30L

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

